

Special Issue

Advances in Intelligent Logistics System and Supply Chain Management, 2nd Edition

Message from the Guest Editors

This Special Issue aims to explore and showcase the latest developments, innovations, and advancements in the fields of intelligent logistics systems and supply chain management. Topics of interest include, but are not limited to, artificial intelligence applications, robotics, data analytics, automation, optimization techniques, and emerging technologies that contribute to enhancing the efficiency, resilience, and sustainability of logistics and supply chain operations. The scope of this Special Issue encompasses research articles, case studies, and reviews that provide valuable insights into the integration of intelligent systems to address challenges and foster improvements in logistics and supply chain management.

Guest Editors

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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